



Mosfet Bending Machine - MBM 280

The Manual MOSFET Bending Machine is designed for precise and uniform bending of TO-220 package component leads like MOSFETs and IGBTs. It ensures quick, consistent bends for easy PCB mounting, making it ideal for electronics assembly.



Specifications:

Model	MBM 10
Operation Mode	Pneumatic
Air Pressure	40 PSI
Compatible Components	TO-220 Package (MOSFETs, IGBTs, Voltage Regulators, etc.)
Lead Bending Capacity	Typically up to 1.5 mm Lead Thickness
Bending Style	Uniform Right-Angle Bends for PCB Insertion
Weight	8 Kg

Features:

- Provides uniform and consistent bends, ensuring correct component alignment for PCB mounting.
- Durable metal body ensures long life and reliable operation under regular use.
- Automatic press operation—electricity required—ideal for both workshop and field use.
- Speeds up lead-forming process compared to manual plier-based methods.
- Suitable for various TO-220 components like MOSFETs, IGBTs, and Voltage Regulators.

ERGONOMIC AND VERSATILE, TRUSTED BY PROFESSIONALS



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